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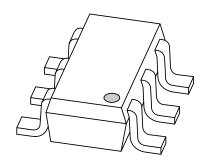
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Team Nexperia

# DISCRETE SEMICONDUCTORS

# DATA SHEET



# **PBSS4140DPN**40 V low V<sub>CEsat</sub> NPN/PNP transistor

Product data sheet 2001 Dec 13



# 40 V low V<sub>CEsat</sub> NPN/PNP transistor

# PBSS4140DPN

### **FEATURES**

- 600 mW total power dissipation
- · Low collector-emitter saturation voltage
- · High current capability
- Improved device reliability due to reduced heat generation
- Replaces two SOT23 packaged low V<sub>CEsat</sub> transistors on same PCB area
- · Reduces required PCB area
- · Reduced pick and place costs.

### **APPLICATIONS**

- General purpose switching and muting
- · LCD backlighting
- Supply line switching circuits
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

### **DESCRIPTION**

NPN/PNP low  $V_{\text{CEsat}}$  transistor pair in an SC-74 (SOT457) plastic package.

### **MARKING**

TYPE NUMBER	MARKING CODE
PBSS4140DPN	M2

### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	40	V
I <sub>C</sub>	peak collector current	1	Α
I <sub>CM</sub>	peak collector current	2	Α
TR1	NPN	_	_
TR2	PNP	_	_
R <sub>CEsat</sub>	equivalent on-resistance	<500	mΩ

### **PINNING**

PIN		DESCRIPTION		
1, 4	emitter	TR1; TR2		
2, 5	base	TR1; TR2		
6, 3	collector	TR1; TR2		

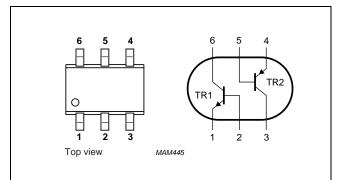


Fig.1 Simplified outline SC74 (SOT457) and symbol.

# 40 V low V<sub>CEsat</sub> NPN/PNP transistor

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### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
Per transis	Per transistor; for the PNP transistor with negative polarity				
V <sub>CBO</sub>	collector-base voltage	open emitter	-	40	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	5	V
I <sub>C</sub>	collector current (DC)		_	1	А
I <sub>CM</sub>	peak collector current		_	2	А
I <sub>BM</sub>	peak base current		_	1	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	370	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C
Per device	•				
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1		600	mW

### Note

# THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; note 1	208	K/W

## Note

1. Device mounted on a printed-circuit board, single side copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.

<sup>1.</sup> Device mounted on a printed-circuit board, single side copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.

# 40 V low $V_{CEsat}$ NPN/PNP transistor

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### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

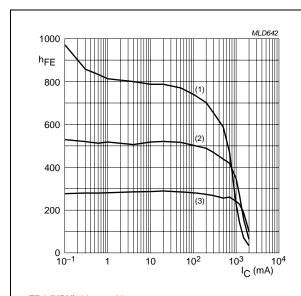
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transistor unless otherwise specified; for the PNP transistor with negative polarity						
I <sub>CBO</sub> collector-base cut-off current		V <sub>CB</sub> = 40 V; I <sub>E</sub> = 0	_	_	100	nA
		V <sub>CB</sub> = 40 V; I <sub>E</sub> = 0; T <sub>j</sub> = 150 °C	_	_	50	μΑ
I <sub>CEO</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0	_	_	100	nA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0	_	_	100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 mA	300	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	I <sub>C</sub> = 100 mA; I <sub>B</sub> = 1 mA	_	_	200	mV
	voltage	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA	_	_	250	mV
		I <sub>C</sub> = 1 A; I <sub>B</sub> = 100 mA	_	_	500	mV
NPN trans	istor		•		•	•
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 500 mA	300	_	900	
		V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 A	200	_	_	
V <sub>BEsat</sub>	base-emitter saturation voltage			_	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	V <sub>CE</sub> = 5 V; I <sub>C</sub> = 1 A	_	_	1.1	V
R <sub>CEsat</sub>	equivalent on-resistance	I <sub>C</sub> = 500 mA; I <sub>B</sub> = 50 mA; note 1	_	260	<500	mΩ
f <sub>T</sub>	transition frequency	V <sub>CE</sub> =10 V; I <sub>C</sub> = 50 mA; f = 100 MHz	150	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	10	pF
PNP trans	istor		•			•
h <sub>FE</sub>	DC current gain	$V_{CE} = -5 \text{ V}; I_{C} = -100 \text{ mA}$	300	_	800	
		$V_{CE} = -5 \text{ V}; I_{C} = -500 \text{ mA}$	250	_	_	
		$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$	160	_	_	
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-1.1	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -5 \text{ V}; I_{C} = -1 \text{ A}$	_	_	-1.0	V
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = -500 \text{ mA}$ ; $I_B -50 \text{ mA}$ ; note 1	_	300	<500	mΩ
f <sub>T</sub>	transition frequency	$V_{CE} = -10 \text{ V}; I_{C} = -50 \text{ mA};$ f = 100 MHz	150	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	12	pF

# Note

1. Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 

# 40 V low V<sub>CEsat</sub> NPN/PNP transistor

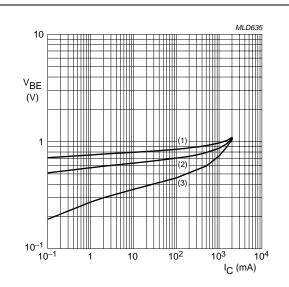
# PBSS4140DPN



**TR1 (NPN);**  $V_{CE} = 5 \text{ V}.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

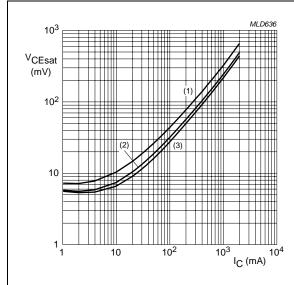
Fig.2 DC current gain as a function of collector current; typical values.



**TR1 (NPN);**  $V_{CE} = 5 \text{ V}.$ 

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

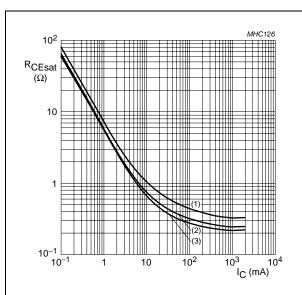
Fig.3 Base-emitter voltage as a function of collector current; typical values.



**TR1 (NPN);**  $I_{C}/I_{B} = 10$ .

- (1)  $T_{amb} = 150 \,^{\circ}C$ .
- (2) T<sub>amb</sub> = 25 °C.
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



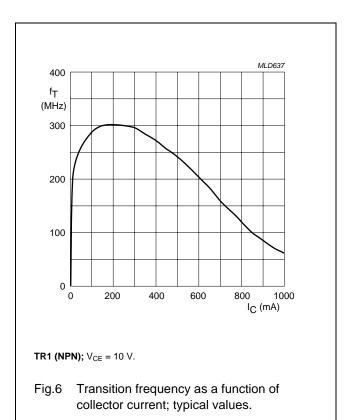
**TR1 (NPN)**;  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2) T<sub>amb</sub> = 25 °C.
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

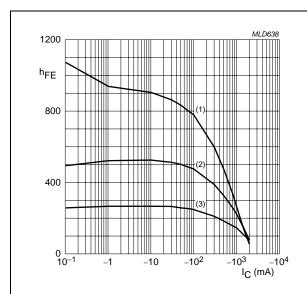
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# 40 V low V<sub>CEsat</sub> NPN/PNP transistor

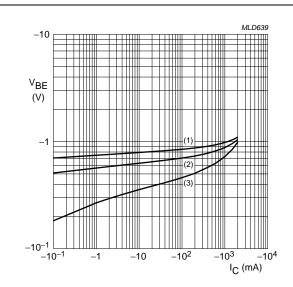
# PBSS4140DPN



**TR2 (PNP);**  $V_{CE} = -5 \text{ V}.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55$  °C.

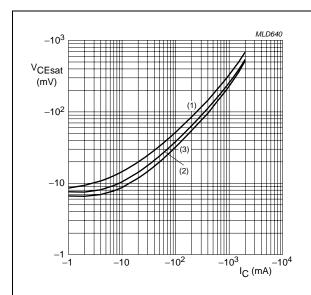
Fig.7 DC current gain as a function of collector current; typical values.



**TR2 (PNP);**  $V_{CE} = -5 \text{ V}.$ 

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

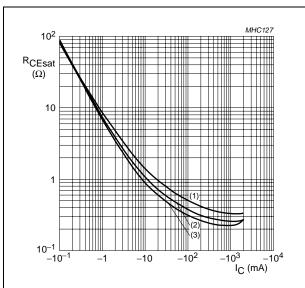
Fig.8 Base-emitter voltage as a function of collector current; typical values.



TR2 (PNP);  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \,^{\circ}C$ .
- (2) T<sub>amb</sub> = 25 °C.
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.



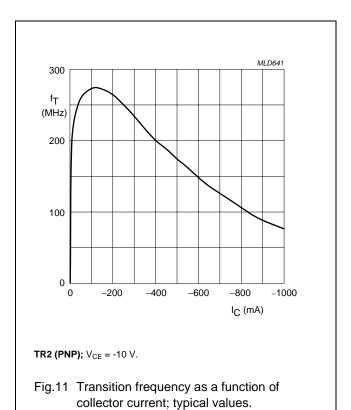
**TR2 (PNP)**;  $I_C/I_B = 10$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.10 Equivalent on-resistance as a function of collector current; typical values.

# 40 V low $V_{CEsat}$ NPN/PNP transistor

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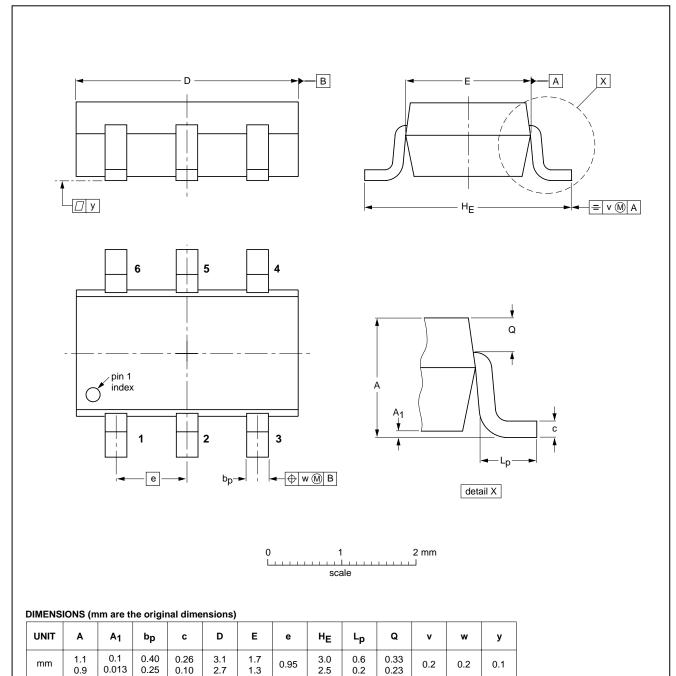
# 40 V low $V_{CEsat}$ NPN/PNP transistor

# PBSS4140DPN

### **PACKAGE OUTLINE**

# Plastic surface mounted package; 6 leads

**SOT457** 



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT457			SC-74			<del>97-02-28</del> 01-05-04

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0.25

# 40 V low V<sub>CEsat</sub> NPN/PNP transistor

# PBSS4140DPN

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DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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